TITLE: SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTOR STRUCTURES THAT INCLUDE COPPER AND TUNGSTEN Inventor: Chopra et al. Docket No.: 2269-4373.2US

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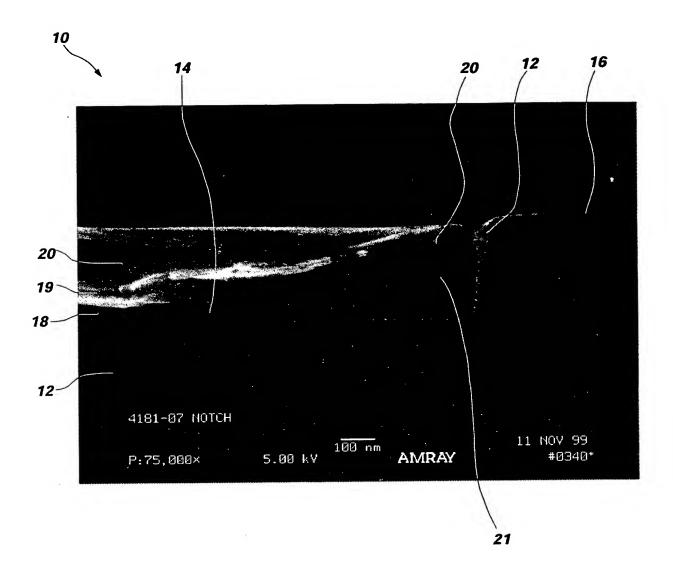
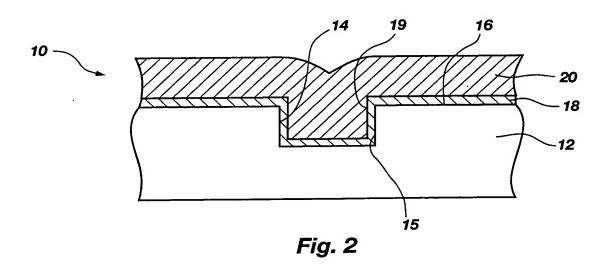


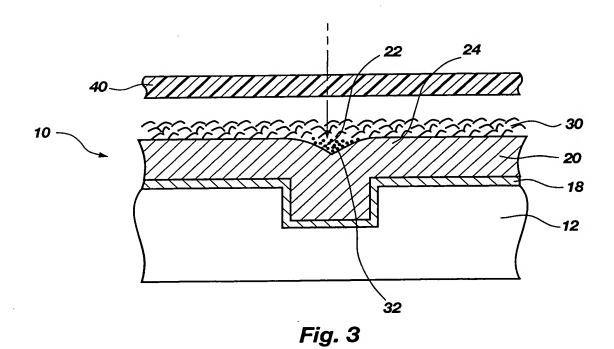
Fig. 1

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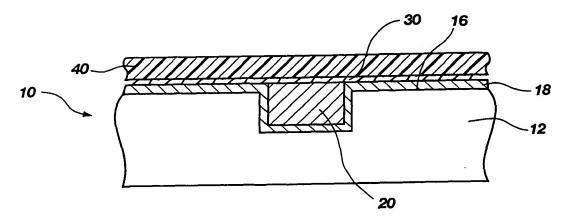


Fig. 4

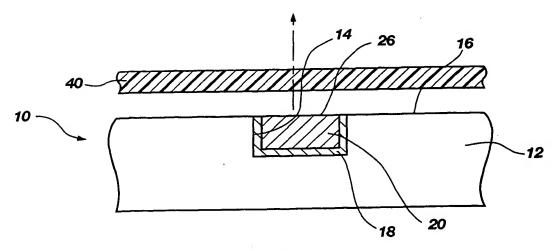


Fig. 5

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